LNA2903L (LN66A)

GaAs Infrared Light Emitting Diode

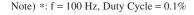
For remote control

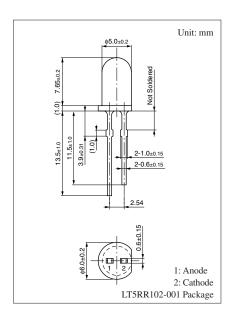
■ Features

- High-power output, high-efficiency: $I_e = 9 \text{ mW/sr (min.)}$
- Emitted light spectrum suited for silicon photodetectors
- Good radiant power output linearity with respect to input current
- Wide directivity: $\theta = 20^{\circ}$ (typ.)
- Transparent epoxy resin package

■ Absolute Maximum Ratings $T_a = 25$ °C

| Parameter | Symbol | Rating | Unit |
|-------------------------------|------------------|-------------|------|
| Reverse voltage | V_R | 3 | V |
| Forward current | I_F | 100 | mA |
| Pulse forward current * | I_{FP} | 1.5 | A |
| Power dissipation | P_{D} | 160 | mW |
| Operating ambient temperature | T_{opr} | -25 to +85 | °C |
| Storage temperature | T_{stg} | -40 to +100 | °C |





■ Electrical-Optical Characteristics $T_a = 25$ °C ± 3 °C

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|-----------------------------|------------------------|--|-----|------|-----|-------|
| Forward voltage | V _F | $I_F = 100 \text{ mA}$ | | 1.4 | 1.6 | V |
| Pulse forward voltage *1 | V _{FP} | $I_{FP} = 1.0 \text{ A}$ | | | 3.0 | V |
| Reverse current | I_R | $V_R = 3 V$ | | | 10 | μΑ |
| Center radiant intensity *2 | I_{e} | $I_F = 50 \text{ mA}$ | 9.0 | | | mW/sr |
| Radiant power | P _O | $I_F = 50 \text{ mA}$ | | 12.0 | | mW |
| Peak emission wavelength | λ_{P} | $I_F = 50 \text{ mA}$ | | 950 | | nm |
| Spectral half band width | Δλ | $I_F = 50 \text{ mA}$ | | 50 | | nm |
| Terminal capacitance | C _t | $V_R = 0 V, f = 1 MHz$ | | 35 | | pF |
| Half-power angle | θ | The angle when the radiant power is halved | | 20 | | ۰ |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Cutoff frequency: 1 MHz

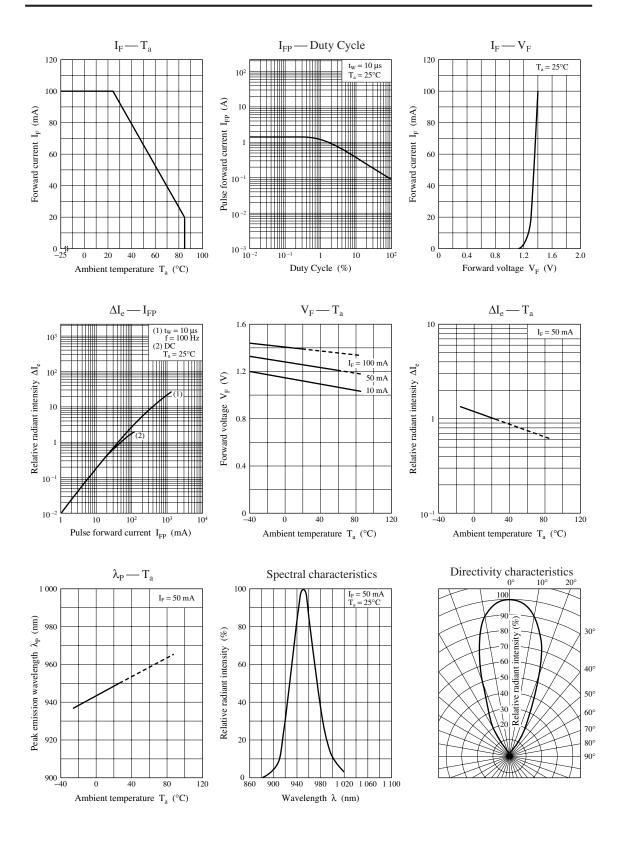
$$f_C$$
: $10 \times log \frac{P_O \text{ at } f = f_C}{P_O \text{ at } f = 50 \text{ kHz}} = -3$

3. *1: f = 100 Hz, Duty Cycle = 0.1%

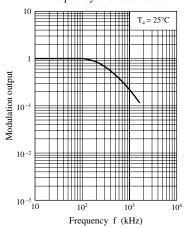
*2: Rank classification

| Rank | No-rank | S |
|------------------------|---------|--------|
| I _e (mW/sr) | > 9.0 | > 11.0 |

Note) The part number in the parenthesis shows conventional part number.



Frequency characteristics



SHC00032BED 3

Caution for Safety

⚠ DANGER

■ This product contains Gallium Arsenide (GaAs).

GaAs powder and vapor are hazardous to human health if inhaled or ingested. Do not burn, destroy, cut, cleave off, or chemically dissolve the product. Follow related laws and ordinances for disposal. The product should be excluded form general industrial waste or household garbage.

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